

Features

1) Low on-resistance

2) Fast switching speed

3) Fast reverse recovery

6) Pb-free lead plating ; RoHS compliant

7) Wide creepage distance = min.4.7 mm

4) Easy to parallel

5) Simple to drive

Application

· Solar inverters

DC/DC converters

Induction heating

Motor drives

· Switch mode power supplies

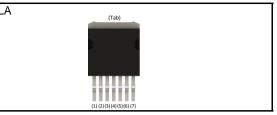
# SCT4090KWA

N-channel SiC power MOSFET

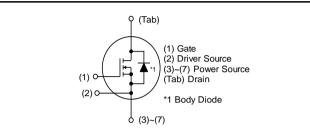
V <sub>DSS</sub>	1200V
R <sub>DS(on)</sub> (Typ.)	90mΩ
ا <sub>D</sub> *1	17A
P <sub>D</sub>	71W

## TO-263-7LA

Outline



### Inner circuit



Please note Driver Source and Power Source are not exchangeable. Their exchange might lead to malfunction.

#### Packaging specifications

	Packing	Embossed tape
	Reel size (mm)	330
Tuno	Tape width (mm)	24
Туре	Basic ordering unit (pcs)	1000
	Taping code	TL
	Marking	SCT4090KWA

## •Absolute maximum ratings (T<sub>vj</sub> = 25°C unless otherwise specified)

	,				
P	arameter		Symbol	Value	Unit
Drain - source voltage		V <sub>DSS</sub>	1200	V	
Continuous drain	$V_{GS} = V_{GS_{on}}$	$T_c = 25^{\circ}C$	*1	17	А
and source current	$v_{GS} = v_{GS_{on}}$	$T_c = 100^{\circ}C$	۰ ا <sub>D</sub> , I <sub>S</sub> <sup>*1</sup>	12	А
Pulsed drain current	$V_{GS} = V_{GS_{on}}$	$T_c = 25^{\circ}C$	I <sub>D,pulse</sub> *2	45	А
Body diode pulsed forward current $T_c = 25^{\circ}C$		*1,*3 I <sub>S,pulse</sub>	17	А	
Body diode surge forward current $V_{GS} =$		$V_{GS} = 0 V$	*1,*4 I <sub>S,pulse</sub>	45	А
Gate - source voltage (E	DC)		$V_{GSS_{DC}}$	-4 to +21	V
Gate - source surge volt	age (t <sub>surge</sub> < 300	)ns)	$V_{GSS\_surge}$ *5	-4 to +23	V
Recommended turn-on	gate - source dr	ive voltage	V <sub>GS_on</sub> *6	+15 to +18	V
Recommended turn-off gate - source drive voltage		$V_{GS_{off}}$	0	V	
Virtual junction temperature		T <sub>vj</sub>	175	°C	
Range of storage temperature		T <sub>stg</sub>	-40 to +175	°C	

# •Electrical characteristics ( $T_{vj} = 25^{\circ}C$ unless otherwise specified)

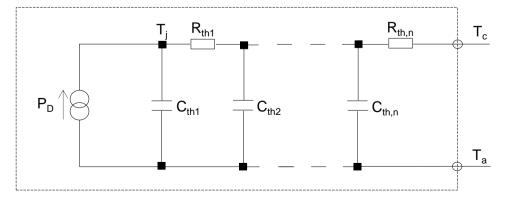
Deremeter	Cumphal	Conditions		Unit			
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Onit	
Drain - Source breakdown	V	$V_{GS} = 0 V, I_{D} = 3.7 mA$				V	
voltage	V <sub>(BR)DSS</sub>	T <sub>vj</sub> = 25°C	1200	-	-	V	
		$V_{GS} = 0 V, V_{DS} = 1200V$					
Zero Gate voltage Drain current	I <sub>DSS</sub>	T <sub>vj</sub> = 25°C	-	1	80	μA	
		T <sub>vj</sub> = 150°C	-	10	-		
Gate - Source leakage current	I <sub>GSS+</sub>	$V_{GS}$ = +21V , $V_{DS}$ = 0V	-	-	100	nA	
Gate - Source leakage current		$V_{GS} = -4V$ , $V_{DS} = 0V$	-	-	-100	nA	
Gate threshold voltage	$V_{GS(th)}{}^{*7}$	$V_{DS} = 10V, I_{D} = 4.44mA$	2.8	-	4.8	V	
		$V_{GS} = 18V, I_{D} = 8.3A$					
Static Drain - Source on - state resistance	${\sf R}_{\sf DS(on)}$ *8	T <sub>vj</sub> = 25°C	-	90	117	mΩ	
		T <sub>vj</sub> = 150°C	-	180	-		
Gate input resistance	$R_G$	f = 1MHz, open drain	-	4	-	Ω	

#### Thermal resistance

Parameter	Symbol	Values			Unit
r arameter		Min.	Тур.	Max.	Offic
Thermal resistance, junction - case	${\sf R_{thJC}}^{*9}$	-	1.6	2.1	K/W

## •Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R <sub>th1</sub>	3.0 ×10 <sup>-1</sup>		C <sub>th1</sub>	2.4 ×10 <sup>-4</sup>	
R <sub>th2</sub>	5.8 ×10 <sup>-1</sup>	K/W	C <sub>th2</sub>	1.0 ×10 <sup>-3</sup>	Ws/K
R <sub>th3</sub>	7.2 ×10 <sup>-1</sup>		C <sub>th3</sub>	2.7 ×10 <sup>-3</sup>	





# •Electrical characteristics ( $T_{vj}$ = 25°C unless otherwise specified)

	O make a			Values		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Transconductance	<b>g</b> <sub>fs</sub> *8	$V_{DS} = 10V, I_{D} = 8.3A$	-	4.1	-	S
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0V$	-	1026	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 800V	-	35	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	3	-	
Effective output capacitance, energy related	C <sub>o(er)</sub>	$V_{GS} = 0V$ $V_{DS} = 0V$ to 800V	-	44	-	pF
Total Gate charge	Q <sub>g</sub> *8	$V_{DS} = 800V$	-	48	-	
Gate - Source charge	Q <sub>gs</sub> *8	I <sub>D</sub> = 8.3A V <sub>GS</sub> = 18V	-	11	-	nC
Gate - Drain charge	ate - Drain charge Q <sub>gd</sub> *8 See Fig. 1-1, 1-2.		-	16	-	
Turn - on delay time	t <sub>d(on)</sub> *8	$V_{DS} = 800V$	-	4.4	-	
Rise time	t <sub>r</sub> *8	I <sub>D</sub> = 8.3A V <sub>GS</sub> = +18V / 0V	-	9.8	-	20
Turn - off delay time	t <sub>d(off)</sub> *8	$R_G = 0\Omega, L = 250\mu H$ E <sub>on</sub> includes diode	-	19	-	ns
Fall time	t <sub>f</sub> *8	reverse recovery $L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF	-	16	-	
Turn - on switching loss	E <sub>on</sub> *8	See Fig. 2-1, 2-2, 2-3.	-	100	-	μJ
Turn - off switching loss	E <sub>off</sub> *8		-	9	-	μυ
V <sub>GS(on)</sub> = +15∖ Short-circuit	- t <sub>sc</sub> <sup>*10</sup>	V <sub>DS</sub> ≤ 800V V <sub>DS,peak</sub> ≤ 1200V	-	4.5	-	μs
withstand time $V_{GS(on)} = +18V$		$T_{vj(start)} = 25^{\circ}C$ $R_{G} = 2.2\Omega$	-	4.0	-	μs



#### •Body diode electrical characteristics (Source-Drain) (T<sub>vi</sub> = 25°C unless otherwise specified)

Doromotor	Symbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward voltage	$V_{SD}^{*8}$	$V_{GS} = 0V, I_{S} = 8.3A$	-	3.3	-	V
Reverse recovery time	t <sub>rr</sub> *8	$I_F = 8.3A$ $V_R = 800V$	-	8.5	-	ns
Reverse recovery charge	Q <sub>rr</sub> *8	di/dt = 3000A/µs	-	90	-	nC
Peak reverse recovery current	I <sub>rrm</sub> *8	$L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF See Fig. 3-1, 3-2.	-	21	-	А

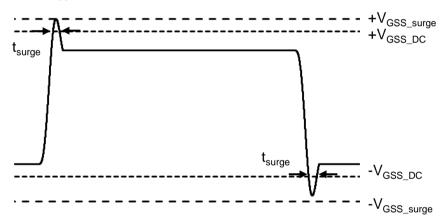
\*1 Limited by maximum  $T_{vi}$  and for Max.  $R_{thJC}$ .

\*2 Pulse width and duty cycle are limited by  $T_{vj,max}$ .

\*3 Only for body-diode, Repetitive pulse, PW  $\leq$  1.5µs, Duty cycle  $\leq$  5%

\*4 When used as a protective function, PW  $\leq$  10µs

\*5 Example of acceptable V<sub>GS</sub> waveform



- \*6 Please be advised not to use SiC-MOSFETs with V<sub>GS</sub> below 10V as doing so may cause thermal runaway.
- \*7 Tested after applying  $V_{GS}$  = 21V for 100ms.

#### \*8 Pulsed

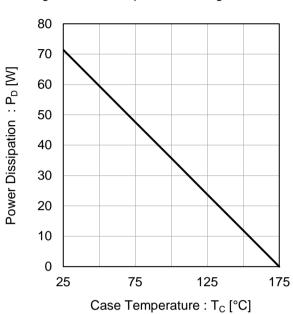
\*9 Measured conformable to JESD51-14.

See the application note "rthjc\_measurement\_and\_usage\_an-e.pdf". Link

 ${\tt URL: https://fscdn.rohm.com/en/products/databook/applinote/discrete/common/rthjc\_measurement\_and\_usage\_an-e.pdf}$ 

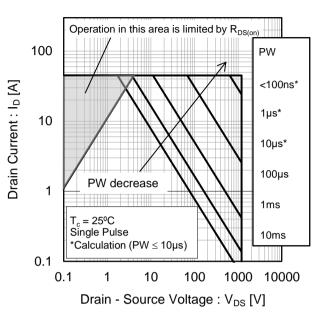
\*10 The value is based on TO-247 package. Single Pulsed.





#### Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area



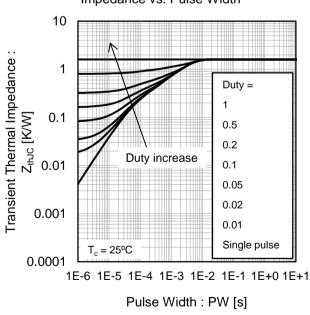
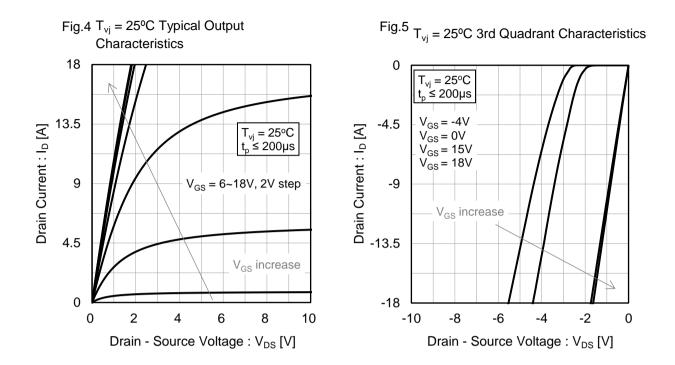


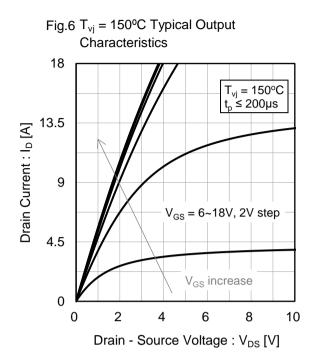
Fig.3 Typical Transient Thermal Impedance vs. Pulse Width

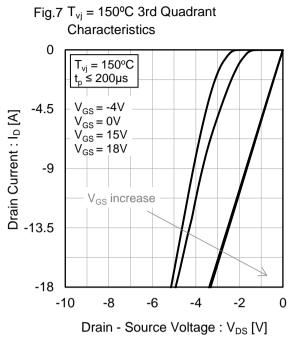


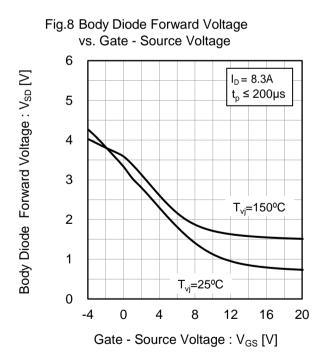
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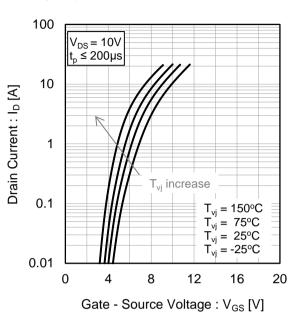
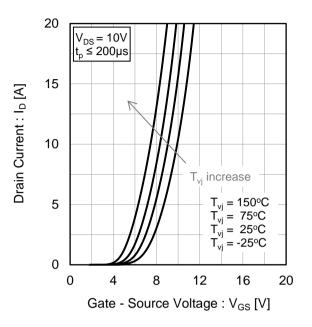


Fig.9 Typical Transfer Characteristics (I)

Fig.10 Typical Transfer Characteristics (II)



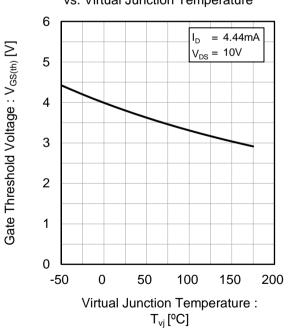


Fig.12 Transconductance vs. Drain Current

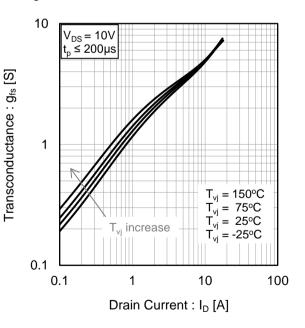
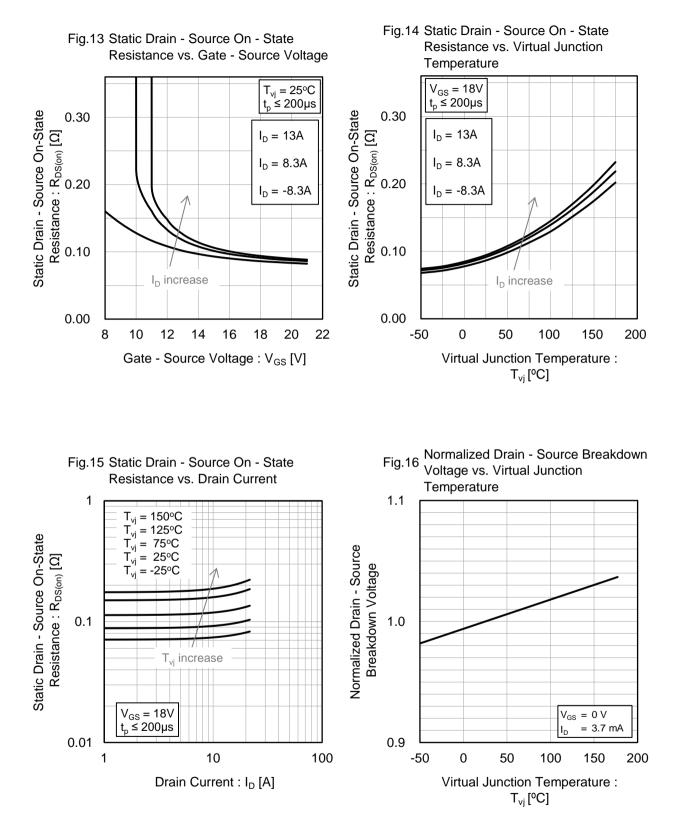


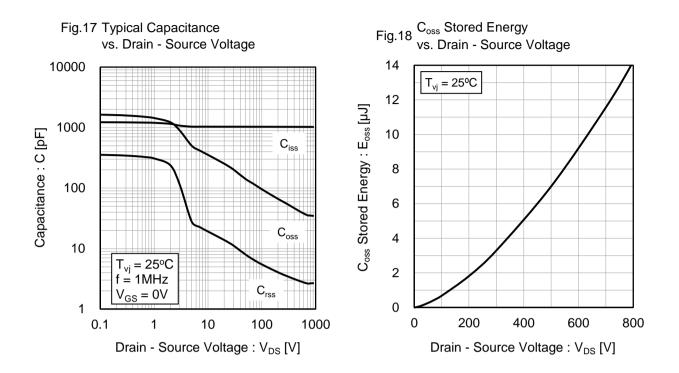
Fig.11 Gate Threshold Voltage vs. Virtual Junction Temperature

8/15

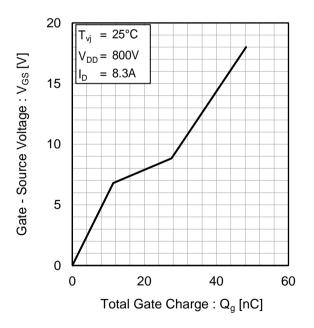




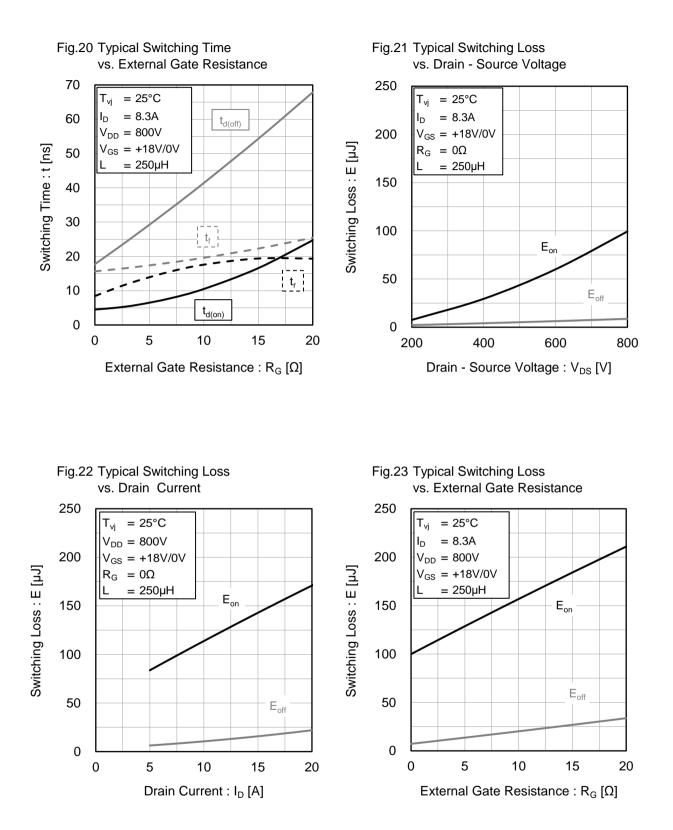


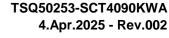


#### Fig.19 Dynamic Input Characteristics









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## Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit

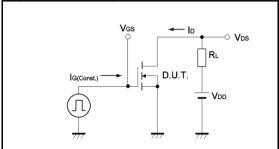
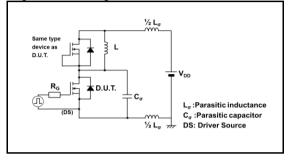


Fig.2-1 Switching Characteristics Measurement Circuit



#### Fig.2-3 Waveforms for Switching Energy Loss

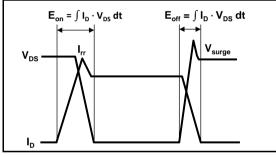
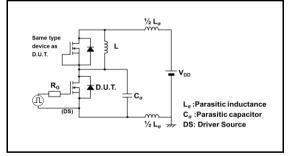
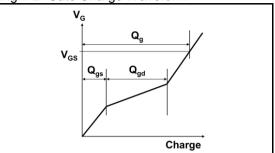


Fig.3-1 Reverse Recovery Time Measurement Circuit



#### Fig.1-2 Gate Charge Waveform





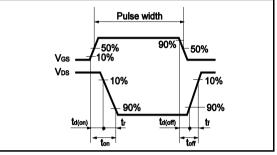
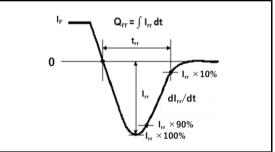
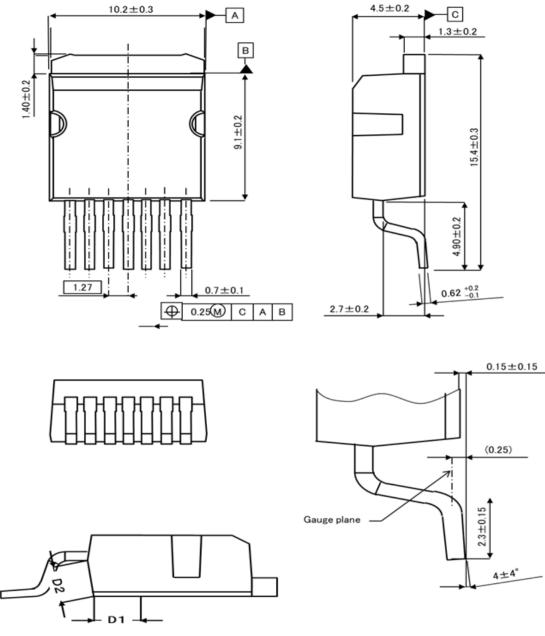


Fig.3-2 Reverse Recovery Waveform





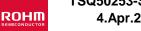
#### Package Dimensions

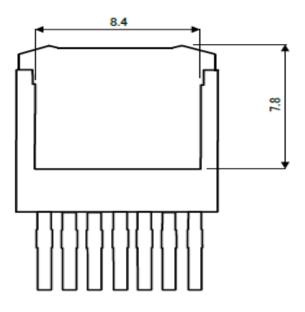


Minimum Creepage Distance = 4.7mm (D1+D2)

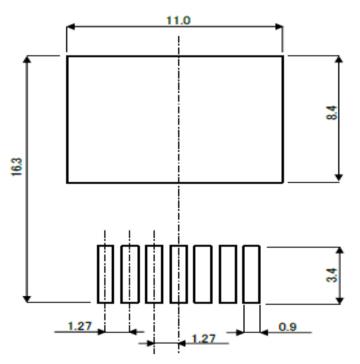
Unit: mm







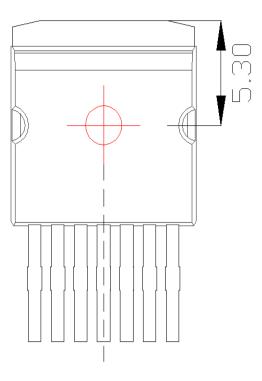
# RECOMMENDED FOOTPRINT DIMENSIONS





#### Die Bonding Layout





•Front view of the packaging.

•Dimensions are design values.

·If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm





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